PCN Number:		20180605000	PCN Date:	Date: June 07, 2018				
Title: Datashee		r CDCE813-Q1						
Cus	stomer Contact:	PCN Manager		Dep	pt:	Quality Services		
Cha	ange Type:							
	Assembly Site		Design		Wafer	Bump Site		
	Assembly Process		Data Sheet			Bump Material		
	Assembly Materials		Part number change		Wafer Bump Process			
	Mechanical Specification		Test Site		Wafer Fab Site			
	Packing/Shipping/	Labeling	Test Process		Wafer	Fab Materials		
					Wafer	Fab Process		
Notification Details								
Description of Change:								
Texas Instruments Incorporated is announcing an information only notification.								
The product datasheet(s) is being updated as summarized below. The following change history provides further details.								
		istory provides fu	irther details.					
	Texas Instruments					CDCE813-Q1		
	INSTRUMENTS		SNAS			5705A – JANUARY 2017 – REVISED MAY 2018		
Changes from Original (January 2017) to Revision A Page								
Changed the Factory Default Setting table and Default Configuration graphic text to show that S0 = 1 means Y1								
			d					
-								
J.	Texas							
-9	INSTRUMENTS			-		CDCE813-Q1		
Cha	Devision A (Anna 2048) to Devicing	P	SNASI	1050 - JAN	UARY 2017-REVISED MAY 2018		
Changes from Revision A (May 2018) to Revision B Page								
 Changed the text in the <i>Default Device Configuration</i> section from: However the outputs are disabled by default and need to be turned on through I2C or with the S0 pin to: However the outputs are disabled by default and need to be turned on through I2C. 								
Changed the Factory Default Setting table and Default Configuration graphic text to show that the Y1 outputs as 3- state when S0 = 1 or S0 = 0								
			:0 bits from: 00b to: 01b in the					
• •	Changed the default value	of the Y1_ST0 3:2 bit	s from: 11b to: 01b in the Gene	ric Confi	iguration	Register table 16		
			its from: 20h to: 00h in the Gen		-			
Changed the default value of the Y2Y3_1 bit from: 1b to: 0b in the PLL1 Configuration Register table								
The datasheet number will be changing.								
De	evice Family		Change From:		Change	e To:		
	CDCE813-Q1		SNAS705		SNAS7	05B		
These changes may be reviewed at the datasheet links provided.								
http://www.ti.com/product/CDCE813-Q1								
Reason for Change:								
To accurately reflect device characteristics.								
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):								
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.								
Changes to product identification resulting from this PCN:								
None.								
Product Affected:								
C	DCE813QPWRQ1							

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail		
USA	PCNAmericasContact@list.ti.com		
Europe	PCNEuropeContact@list.ti.com		
Asia Pacific	PCNAsiaContact@list.ti.com		
Japan	PCNJapanContact@list.ti.com		